



# P-Channel 20-V (D-S) MOSFET

## TrenchFET<sup>®</sup> MOSFETs 1.5-V Rated



### ESD Protected 2000 V

PRODUCT SUMMARY		
V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (mA)
-20	8 @ V <sub>GS</sub> = -4.5 V	-150
	12 @ V <sub>GS</sub> = -2.5 V	-125
	15 @ V <sub>GS</sub> = -1.8 V	-100
	20 @ V <sub>GS</sub> = -1.5 V	-30

### FEATURES

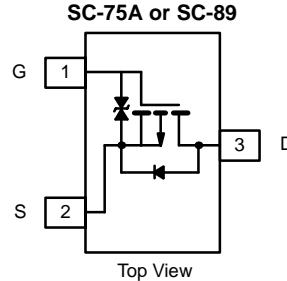
- High-Side Switching
- Low On-Resistance: 8 Ω
- Low Threshold: 0.9 V (typ)
- Fast Switching Speed: 45 ns
- 1.8-V Operation
- Gate-Source ESD Protection

### BENEFITS

- Ease in Driving Switches
- Low Offset (Error) Voltage
- Low-Voltage Operation
- High-Speed Circuits
- Low Battery Voltage Operation

### APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers



SC-75A (SOT- 416): Si1031R  
 SC-89 (SOT- 490): Si1031X

Marking Code: H

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C UNLESS OTHERWISE NOTED)							
Parameter	Symbol	Si1031R		Si1031X		Unit	
		5 secs	Steady State	5 secs	Steady State		
Drain-Source Voltage	V <sub>DS</sub>	-20				V	
Gate-Source Voltage	V <sub>GS</sub>	±6					
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	I <sub>D</sub>	T <sub>A</sub> = 25 °C	-150	-140	-165	-155	mA
		T <sub>A</sub> = 85 °C	-110	-100	-150	-125	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	-500		-600		mW	
Continuous Source Current (diode conduction) <sup>a</sup>	I <sub>S</sub>	-250	-200	-340	-240		
Maximum Power Dissipation <sup>a</sup>	P <sub>D</sub>	T <sub>A</sub> = 25 °C	280	250	340	300	mW
		T <sub>A</sub> = 85 °C	145	130	170	150	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150				°C	
Gate-Source ESD Rating (HBM, Method 3015)	ESD	2000				V	

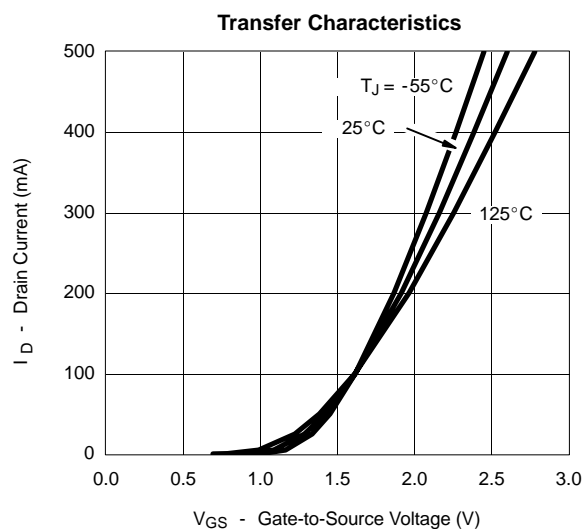
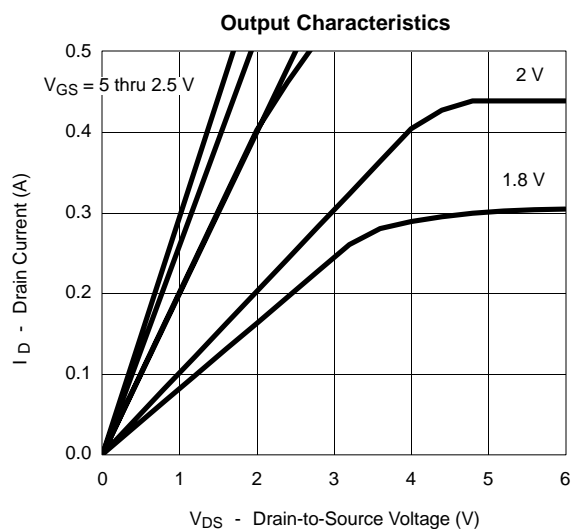
Notes  
 a. Surface Mounted on FR4 Board.

**SPECIFICATIONS (T<sub>A</sub> = 25 °C UNLESS OTHERWISE NOTED)**

Parameter	Symbol	Test Condition	Min	Typ <sup>a</sup>	Max	Unit
<b>Static</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA	-0.40		-1.20	V
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±2.8 V		±0.5	±1	μA
		V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±4.5 V		±1	±2	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -16 V, V <sub>GS</sub> = 0 V		-1	-500	nA
		V <sub>DS</sub> = -16 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 85 °C			-10	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = -5 V, V <sub>GS</sub> = -4.5 V	-200			mA
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -150 mA			8	Ω
		V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -125 mA			12	
		V <sub>GS</sub> = -1.8 V, I <sub>D</sub> = -100 mA			15	
		V <sub>GS</sub> = -1.5 V, I <sub>D</sub> = -30 mA			20	
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -150 mA		0.4		S
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = -150 mA, V <sub>GS</sub> = 0 V			-1.2	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -150 mA		1500		pC
Gate-Source Charge	Q <sub>gs</sub>			150		
Gate-Drain Charge	Q <sub>gd</sub>			450		
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = -10 V, R <sub>L</sub> = 65 Ω I <sub>D</sub> ≅ -150 mA, V <sub>GEN</sub> = -4.5 V, R <sub>G</sub> = 10 Ω			55	ns
Rise Time	t <sub>r</sub>				30	
Turn-Off Delay Time	t <sub>d(off)</sub>				60	
Fall Time	t <sub>f</sub>				30	

## Notes

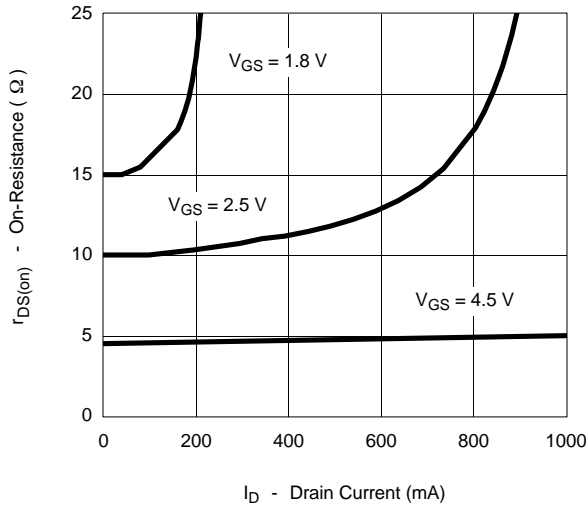
- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.  
b. Guaranteed by design, not subject to production testing.

**TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C UNLESS NOTED)**

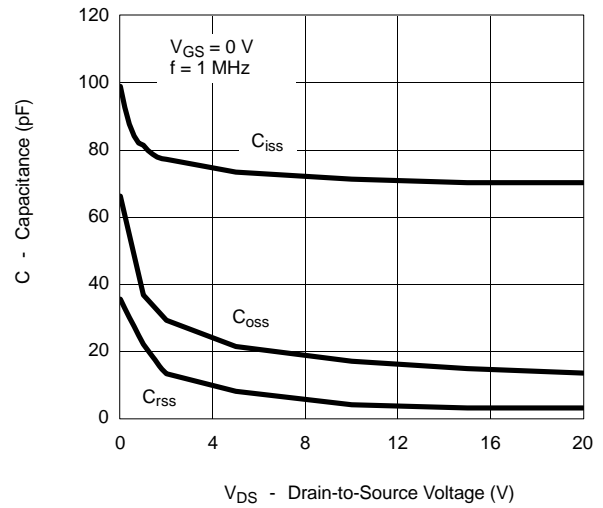


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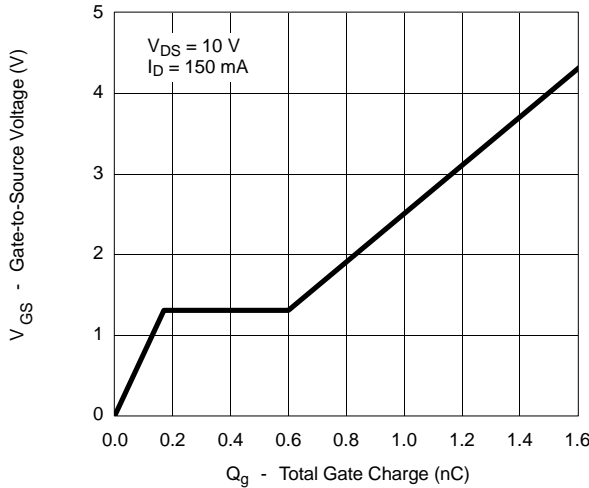
**On-Resistance vs. Drain Current**



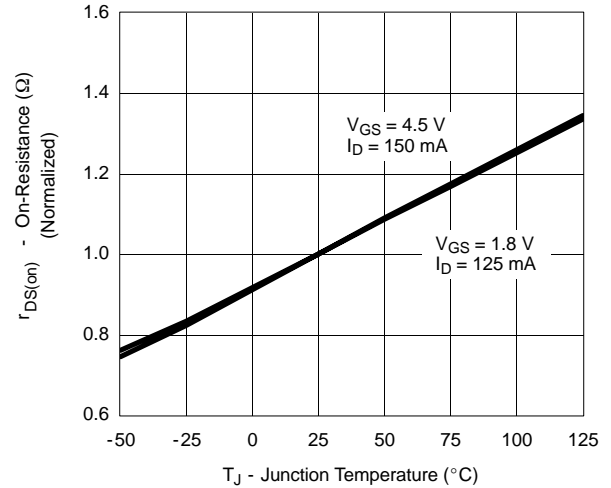
**Capacitance**



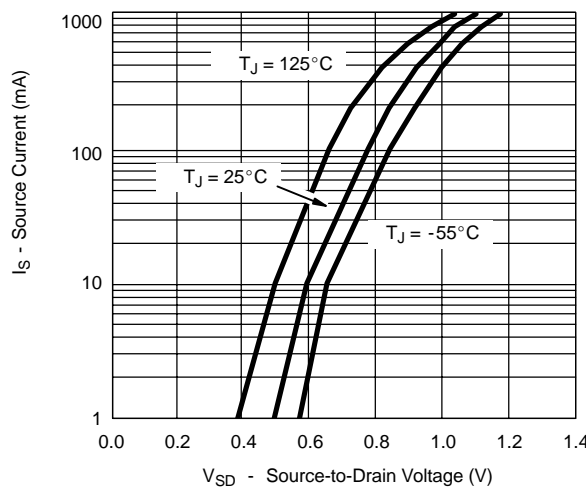
**Gate Charge**



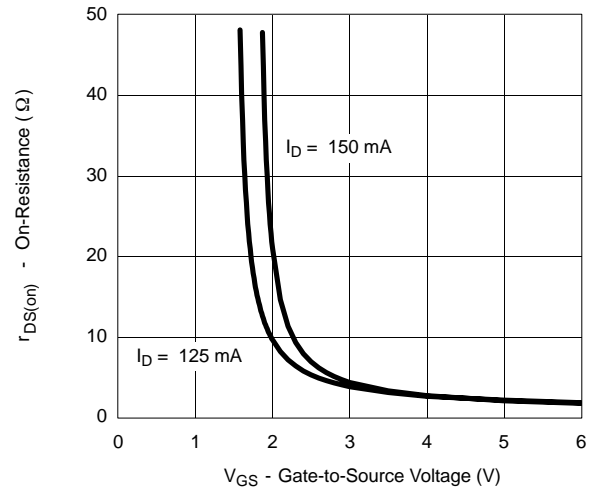
**On-Resistance vs. Junction Temperature**



**Source-Drain Diode Forward Voltage**



**On-Resistance vs. Gate-to-Source Voltage**



**TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C UNLESS NOTED)**

